7th IEEE Electron Devices Technology and Manufacturing (EDTM) Conference 2023

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T3. Advances in Manufacturing and Processing Technologies	
Session Date:	March 7(Tue.),2023
Session Time:	9:00-12:20
Session Room:	F (#317)

[T3-1]	**09:00-10:00**

Introduction to Advanced Packaging Technology for HI

Sarah Eunkyung Kim

Seoul National University of Science and Technology

[T3-2]	**10:10-11:10**

The Value of Memory Packaging in Heterogeneous Integration

Ki-Ill Moon

SK Hynix

[T3-3]	**11:20-12:20**

HI PIM AI Processor's Perspective on HI Architecture, HBM3/4 Integration, PHY, PI/SI, Interposer, and Substrate

Youngsu Kwon

ETRI